



# 1/6-Size Crystal Can Welded • DPDT Dry Circuit to 1 Amp



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## SPECIFICATIONS

#### **GENERAL**

Contact Arrangement	2PDT (2 Form C)
Weight	0.15 oz approx.
Designed to meet the requiremen	ts of MIL-PRF-39016.

#### PERFORMANCE

Contact	Rating	(Note 1)
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	1 Amp @ 28 VDC (Case Ungrounded)
Low Level	10-50 μA @ 10-50 mv DC
	or peak AC (Note 4)
Life	
	@ rated load, 125°C
Pull In Power	100 mw approx.
<b>Operate/Release Tir</b>	ne3.5 ms max, excluding
	bounce time at nominal coil voltage
<b>Contact Bounce Tin</b>	<b>1e</b> 2 ms max @ 1 Amp 28 VDC
<b>Contact Resistance</b>	
Before Life	0.050 Ohms max @ 1 Amp
	and 6 VDC
After Life	0.100 Ohms max @ 1 Amp
	and 6 VDC

#### **ENVIRONMENTAL**

Temperature Range	65°C to +125°C
Vibration (Note 2)	
	20 G's 38 - 2,000 Hz
Shock (Operating) (Note 2)	50 G's 11 ms

### ELECTRICAL CHARACTERISTICS

Duty Cycle	Continuous
Insulation Resistance	
	10,000 megohms @ 500V 25°C
	1,000 megohms @ 500V 125°C
Dielectric Strength:	
Sea Level:	
Contact to Case	
Contact to Coil	
Coil to Case	
Across Open Cont	acts350 VRMS
70,000 Feet	
All points	

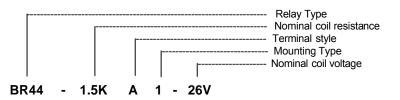
#### Notes

- 1. For case grounded loads and other ratings, consult the factory.
- 2. For applications requiring other shock and vibration levels, consult the factory.
- 3. For other ratings consult the factory.
- 4. Relay contacts which have switched high level currents are no longer suitable for switching low level loads.

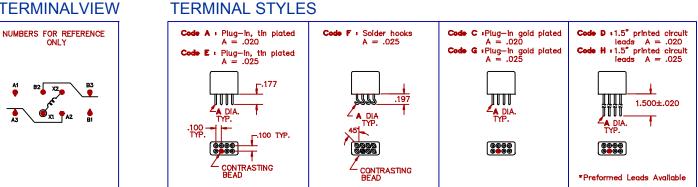


#### **COIL DATA**

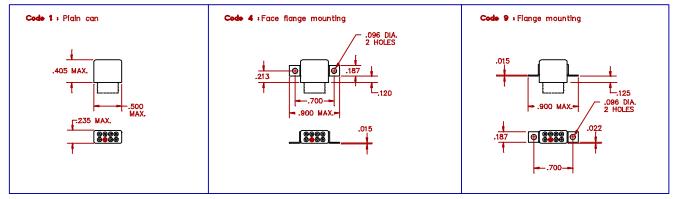
MODEL BR44 PART NUMBER	BR44-90()()-6V	BR44-330()()-12V	BR44-750()()-18V	BR44-1.5K()()-26V
NOMINAL COIL VOLTAGE	6 VDC	12 VDC	18 VDC	26 VDC
MAXIMUM COIL VOLTAGE	7.3 VDC	14.8 VDC	22 VDC	32 VDC
PULL IN VOLTAGE (MAX @ +125°C)	4.4 VDC	8.4 VDC	13 VDC	18 VDC
PULL IN VOLTAGE (MAX)	3 VDC	6 VDC	9 VDC	13 VDC
DROP OUT VOLTAGE (MIN)	0.3 VDC	0.6 VDC	0.9 VDC	1.3 VDC
COIL RESISTANCE ± 10% @ 25°C	90 OHMS	330 OHMS	750 OHMS	1500 OHMS



#### SCHEMATIC TERMINALVIEW



## **MOUNTING CODES**



#### **GENERAL NOTES**

- Unless otherwise specified, all tests made at nominal coil voltages, @ 25°C.
- For special coil variations, switching configurations, terminals styles and mounting types, consult the factory.
- Unless otherwise specified, tolerances on decimal dimensions are ± .010".
- Specifications contained herein are subject to change without notice.



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